

FORM PTO-1449

Department of Commerce  
Patent and Trademark Office

Atty. Docket No.  
P29987

Application No.  
10/595,914

**INFORMATION DISCLOSURE STATEMENT  
BY APPLICANT**  
(Use several sheets if necessary)

Applicant  
Akira OTANI et al.

Filing Date  
I.A. Filed December 2, 2004

Group  
1773

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	2001 /	0 0 0 8 1 6 9	07/19/01	CONNELL et al.			
		5 2 4 0 7 6 1	08/31/93	CALHOUN et al.			

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	1 1	- 1 2 1 0 7 2	04/30/99	JAPAN			
	2 0 0 2	- 5 1 9 4 7 3	07/02/02	JAPAN			
	2 0 0 0	- 1 4 9 6 7 7	05/30/00	JAPAN			
	2 0 0 2	- 3 5 8 8 2 5	12/13/02	JAPAN			
	2 0 0 3	- 0 6 4 3 2 4	03/05/03	JAPAN			
	2	- 1 1 7 9 8 0	05/02/90	JAPAN			
	6	- 3 4 9 3 3 9	12/22/94	JAPAN			
		2 8 9 5 8 7 2	03/05/99	JAPAN			
		3 1 6 5 4 7 7	03/02/01	JAPAN			
	6	- 0 6 0 7 1 2	03/04/94	JAPAN			
	6	- 0 4 5 0 2 4	02/18/94	JAPAN			

**OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)**

1	English Language Abstract of JP 11-121072.
2	English Language Abstract of JP 2000-149677.
3	English Language Abstract of JP 2002-358825.
4	English Language Abstract of JP 2003-064324.
5	English Language Abstract of JP 6-349339.
6	English Language Abstract of JP 2895872.
7	English Language Abstract of JP 3165477.
8	English Language Abstract of JP 6-060712.
9	English Language Abstract of JP 6-045024.
10	U.S. Application Serial No. 10/567,022 filed February 3, 2006 and entitled "COMPOSITE POROUS MEMBRANE AND PROCESS FOR PRODUCING THE SAME".
11	U.S. Application Serial No. 10/574,837 filed April 6, 2006 and entitled "POLYOXYMETHYLENE RESIN COMPOSITION AND MOLDINGS THEREOF".
12	U.S. Application Serial No. 10/576,259 filed April 18, 2006 and entitled "POLYTRIMETHYLENE TEREPHTHALATE REINFORCED RESIN COMPOSITION".
13	U.S. Application Serial No. 10/582,556 filed June 9, 2006 and entitled "THERMOPLASTIC RESIN COMPOSITION".
14	U.S. Application Serial No. 10/597,091 filed July 11, 2006 and entitled "RESIN AND RESIN COMPOSITION".
15	U.S. Application Serial No. 10/597,336 filed July 20, 2006 and entitled "POLYACETAL RESIN COMPOSITION".

EXAMINER /Adam Krupicka/

DATE CONSIDERED 11/21/2009

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.